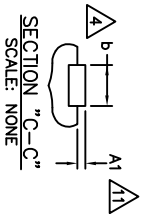
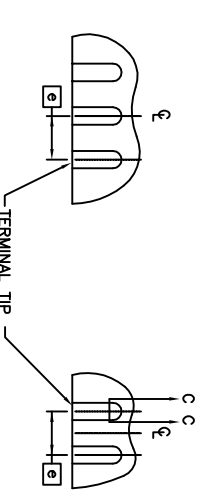
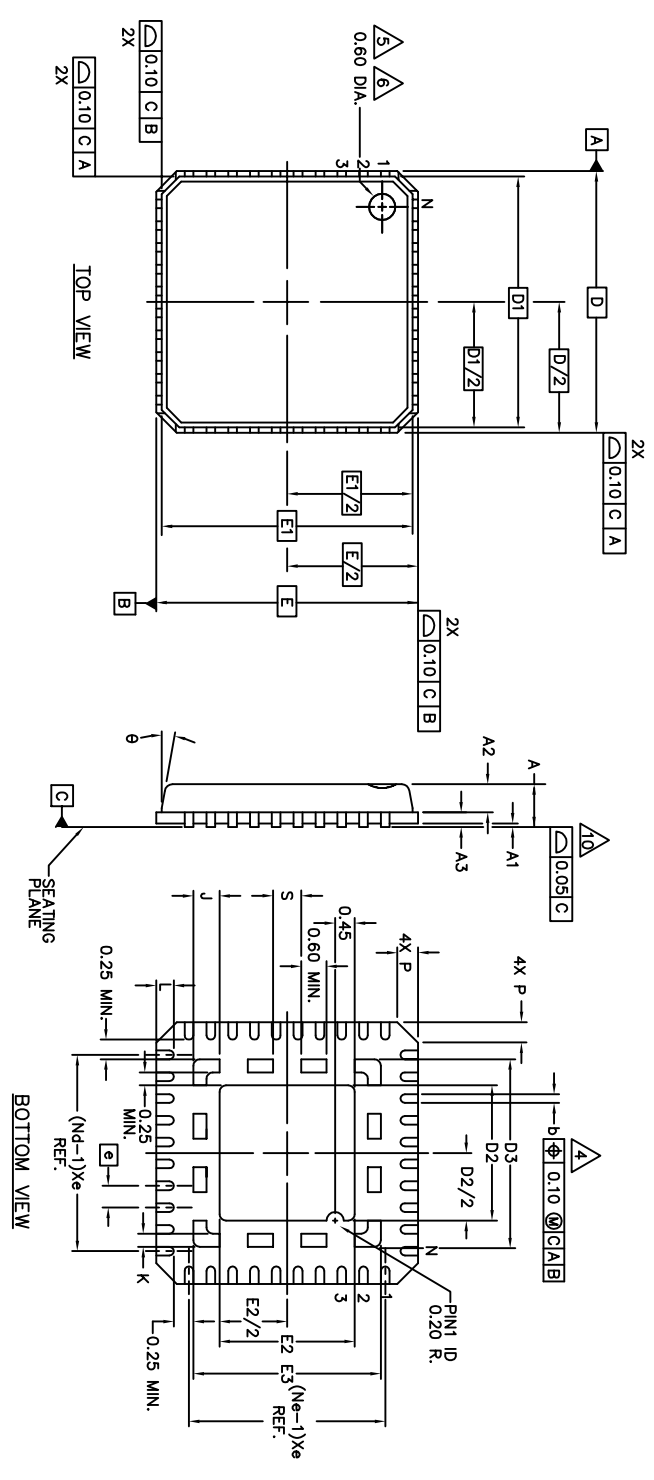



NOTES : ANY MOLD FLASH ON THE RING PAD AREA SHALL BE ALLOWABLE.

MIXED RING HIGH DENSITY LEADFRAME



FOR ODD TERMINAL/SIDE

FOR EVEN TERMINAL/SIDE

Avicor Technology, Inc. USA
 Avicor Semiconductor, Inc.
 Avicor Korea Engineering, Inc.
 Avicor, Philippines


PACKAGE OUTLINE, MLF2, 6 X 6 mm BODY
 4527B
 PRINTING IS SCALED TO FIT
 DO NOT SCALE DRAWING
 3 of 8
 06